

Transaction Information

Wafer Size	200 mm

General Product Information

Vendor Supplier	Lam Research
Model	SEZ SP223
Vintage	2003
Asset Description	TRF6 SEZ SP-223 POST ETCH POLYMER REMOVAL F067PE0599M0X04
Software Version	4.0.7
CIM	SEC GEM
Process	POST ETCH POLYMER REMOVAL

Hardware Configuration

System Type	Description	Quantity	Status
Handler System	Single wafer process	1	OK
Factory Interface	SMIF	4	OK
Options System	CDS	3	OK
Main System	main unit	1	OK
Others	NA	0	

Description	Quantity
NA	0